V_{DRM}	=	1800 V
$I_{T(AV)M}$	=	3000 A
$I_{T(RMS)}$	=	4710 A
I_{TSM}	=	50.54×1 A
V_{T0}	=	0.88 V
r_T	=	0.103 mΩ

Phase Control Thyristor

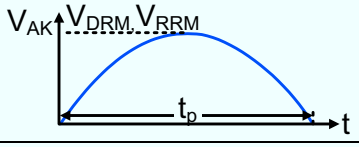
5STP 27H1800

Doc. No. 5SYA1048-03 May 07

- **Patented free-floating silicon technology**
- **Low on-state and switching losses**
- **Designed for traction, energy and industrial applications**
- **Optimum power handling capability**

Blocking

Maximum rated values [1)]

Parameter	Symbol	Conditions	5STP 27H1800	Unit
Max repetitive peak forward and reverse blocking voltage	V_{DRM}, V_{RRM}	f = 50 Hz, t_p = 10 ms, T_{vj} = 5…125°C, Note 1 	1800	V
Critical rate of rise of commutating voltage	dv/dt_{crit}	Exp. to 1210 V, T_{vj} = 125°C	1000	V/µs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward leakage current	I_{DRM}	V_{DRM}, T_{vj} = 125°C			200	mA
Reverse leakage current	I_{RRM}	V_{RRM}, T_{vj} = 125°C			200	mA

Note 1: Voltage de-rating factor of 0.11% per °C is applicable for Tvj below +5 °C

Mechanical data

Maximum rated values [1)]

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_M		45	50	60	kN
Acceleration	a	Device unclamped			50	m/s^2
Acceleration	a	Device clamped			100	m/s^2

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				0.9	kg
Housing thickness	H	F_M = 50 kN, T_a = 25 °C	25.6		26.3	mm
Surface creepage distance	D_S		36			mm
Air strike distance	D_a		15			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

On-state

Maximum rated values [1)]

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	$I_{T(AV)M}$	Half sine wave, T_c = 70 °C			3000	A
RMS on-state current	$I_{T(RMS)}$				4710	A
Peak non-repetitive surge current	I_{TSM}	t_p = 10 ms, T_{vj} = 125 °C, sine wave after surge: $V_D = V_R$= 0 V			50.54×10^3	A
Limiting load integral	I^2t				12.8×10^6	A^2s
Peak non-repetitive surge current	I_{TSM}	t_p = 8.3 ms, T_{vj} = 125 °C, sine wave after surge: $V_D = V_R$= 0 V			53.3×10^3	A
Limiting load integral	I^2t				11.8×10^6	A^2s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	I_T = 3000 A, T_{vj} = 125 °C			1.2	V
Threshold voltage	$V_{(T0)}$	I_T = 2000 A - 6000 A, T_{vj}= 125 °C			0.88	V
Slope resistance	r_T				0.103	mΩ
Holding current	I_H	T_{vj} = 25 °C			70	mA
		T_{vj} = 125 °C			60	mA
Latching current	I_L	T_{vj} = 25 °C			600	mA
		T_{vj} = 125 °C			200	mA

Switching

Maximum rated values [1)]

Parameter	Symbol	Conditions		min	typ	max	Unit
Critical rate of rise of on-state current	di/dt_{crit}	T_{vj} = 125 °C, $I_T = I_{T(AV)}$,	Cont. f = 50 Hz			150	A/µs
Critical rate of rise of on-state current	di/dt_{crit}	$V_D \leq$ 1880 V, I_{FG} = 2 A, t_r = 0.5 µs	Cont. f = 1Hz			1000	A/µs
Circuit-commutated turn-off time	t_q	T_{vj} = 125°C, I_{TRM} = 2000 A, V_R = 200 V, di_T/dt = -1.5 A/µs, $V_D \leq 0.67 \cdot V_{DRM}$, dv_D/dt = 20 V/µs		400			µs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse recovery charge	Q_{rr}	T_{vj} = 125°C, I_{TRM} = 2000 A, V_R = 200 V, di_T/dt = -1.5 A/µs	400		1000	µAs
Reverse recovery current	I_{RM}		15		40	A
Gate turn-on delay time	t_{gd}	T_{vj} = 25 °C, $V_D = 0.4 \cdot V_{RM}$, I_{FG} = 2 A, t_r = 0.5 µs			3	µs

Triggering

Maximum rated values [1)]

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	V_{FGM}				12	V
Peak forward gate current	I_{FGM}				10	A
Peak reverse gate voltage	V_{RGM}				10	V
Average gate power loss	$P_{G(AV)}$			see Fig. 9		W

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate-trigger voltage	V_{GT}	T_{vj} = 25 °C			2.6	V
Gate-trigger current	I_{GT}	T_{vj} = 25 °C			400	mA
Gate non-trigger voltage	V_{GD}	V_D = 0.4 x V_{DRM}, T_{vjmax} = 125 °C	0.3			V
Gate non-trigger current	I_{GD}	V_D = 0.4 x V_{DRM}, T_{vjmax} = 125°C	10			mA

Thermal

Maximum rated values [1)]

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T_{vj}				125	°C
Storage temperature range	T_{stg}		-40		140	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double-side cooled F_m = 45...60 kN			10	K/kW
	$R_{th(j-c)A}$	Anode-side cooled F_m = 45...60 kN			20	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled F_m = 45...60 kN			20	K/kW
Thermal resistance case to heatsink	$R_{th(c-h)}$	Double-side cooled F_m = 45...60 kN			2	K/kW
	$R_{th(c-h)}$	Single-side cooled F_m = 45...60 kN			4	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_i(1 - e^{-t/\tau_i})$$

i	1	2	3	4
R_i(K/kW)	6.640	2.128	0.755	0.500
τ_i(s)	0.4562	0.0593	0.0055	0.0011

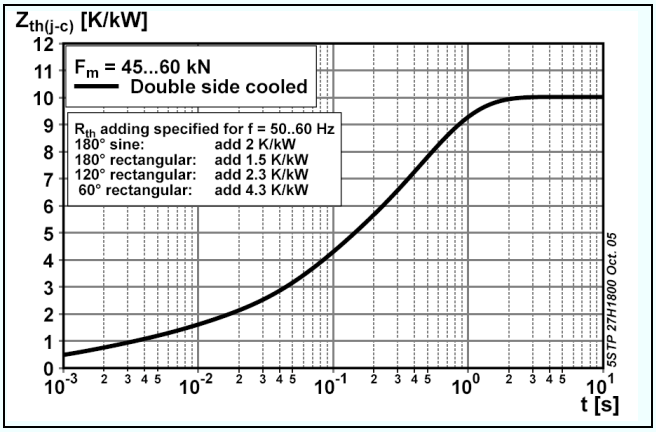


Fig. 1 Transient thermal impedance (junction-to-case) vs. time

Max. on-state characteristic model:

$$V_{T25} = A_{Tvj} + B_{Tvj} \cdot I_T + C_{Tvj} \cdot \ln(I_T + 1) + D_{Tvj} \cdot \sqrt{I_T}$$

Valid for I_T = 300 – 70000 A

A_{25}	B_{25}	C_{25}	D_{25}
123.0×10^{-6}	44.01×10^{-6}	160.2×10^{-3}	-1.771×10^{-3}

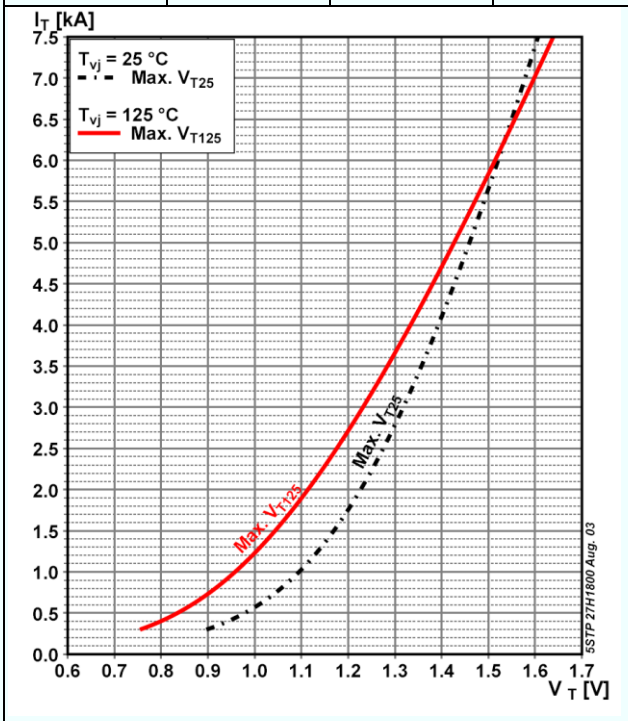


Fig. 2 On-state voltage characteristics

Max. on-state characteristic model:

$$V_{T125} = A_{Tvj} + B_{Tvj} \cdot I_T + C_{Tvj} \cdot \ln(I_T + 1) + D_{Tvj} \cdot \sqrt{I_T}$$

Valid for I_T = 300 – 70000 A

A_{125}	B_{125}	C_{125}	D_{125}
215.3×10^{-6}	60.96×10^{-6}	127.5×10^{-3}	502.4×10^{-6}

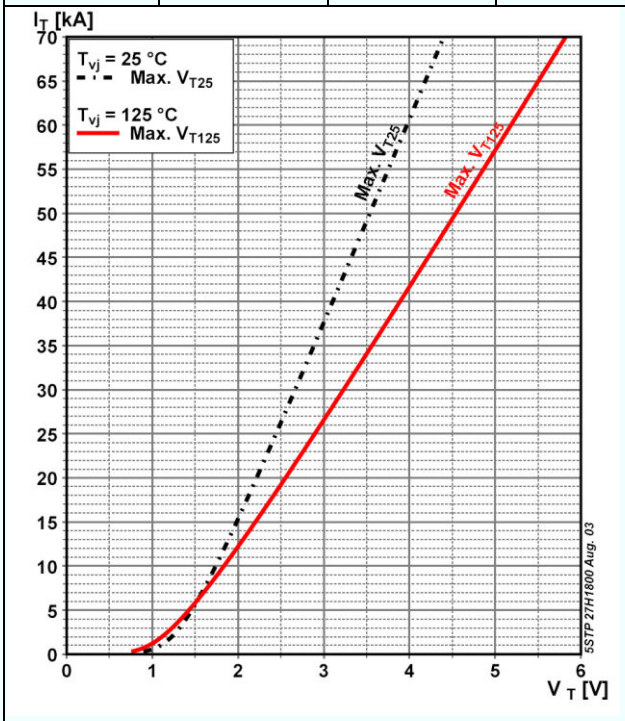


Fig. 3 On-state characteristics, T_j = 125°C, 10ms half sine

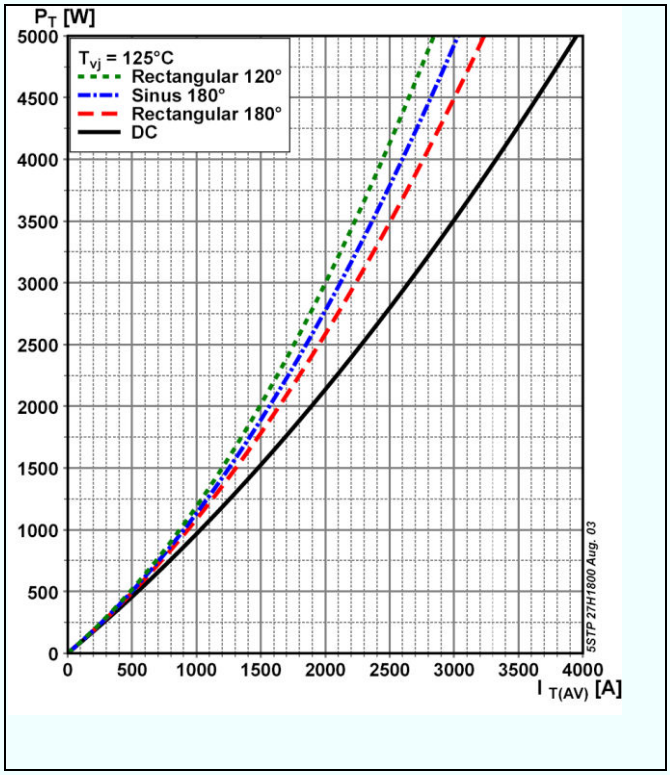


Fig. 4 On-state power dissipation vs. mean on-state current, turn-on losses excluded

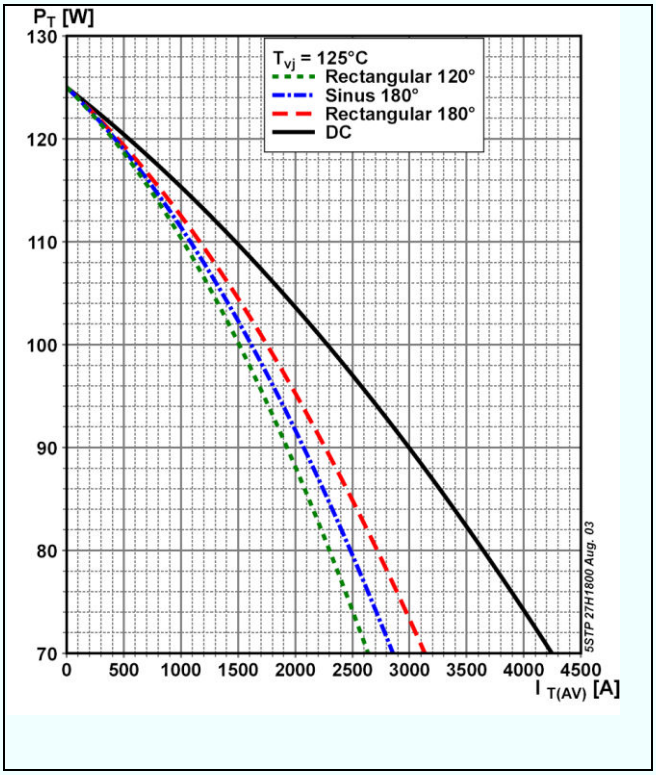


Fig. 5 Max. permissible case temperature vs. mean on-state current, switching losses ignored

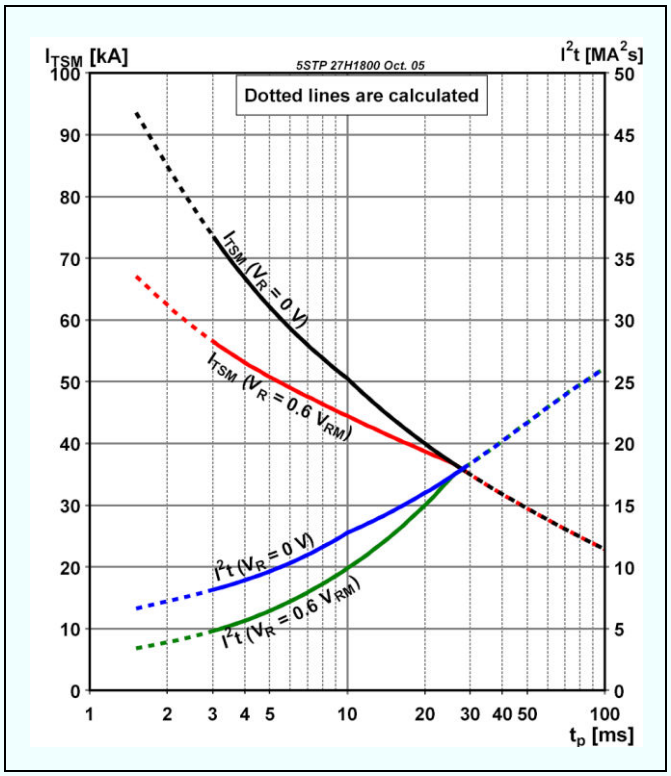


Fig. 6 Surge on-state current vs. pulse length, half-sine wave

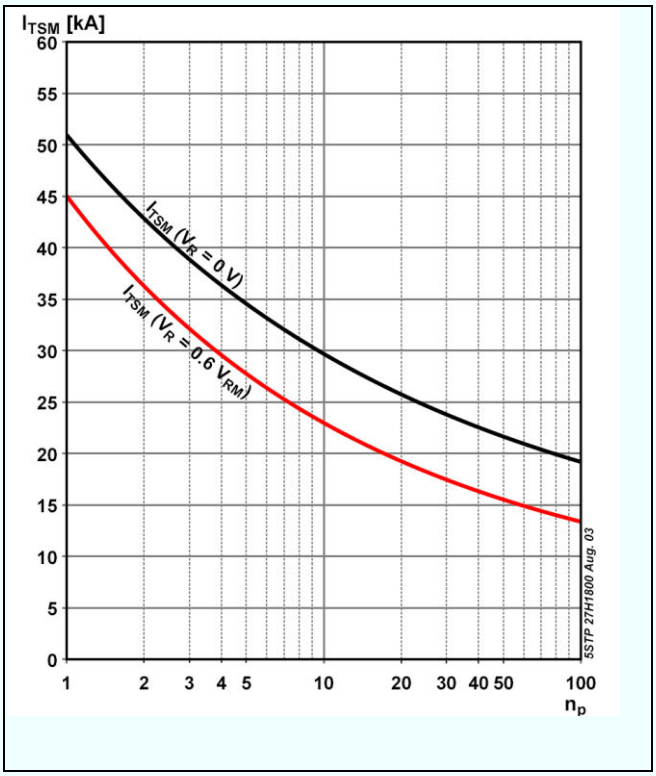


Fig. 7 Surge on-state current vs. number of pulses, half-sine wave, 10 ms, 50Hz

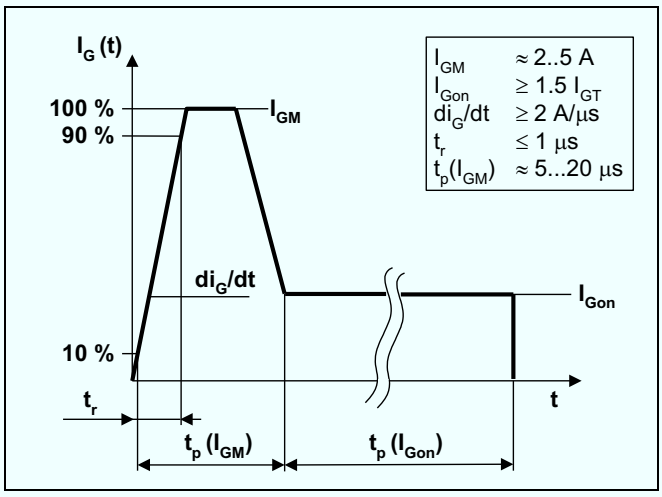


Fig. 8 Recommended gate current waveform

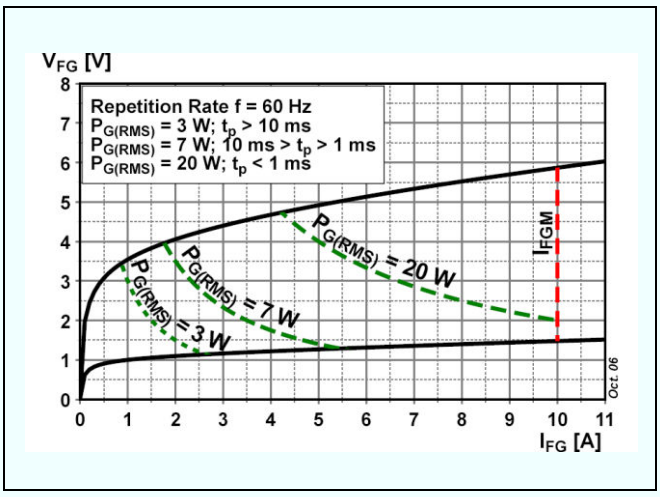


Fig. 9 Max. peak gate power loss

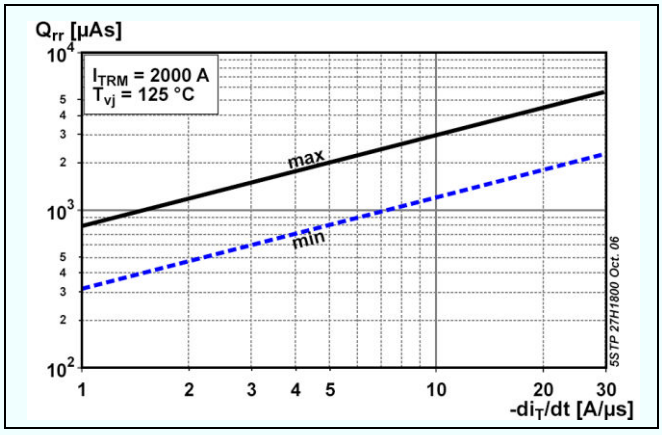


Fig. 10 Reverse recovery charge vs. decay rate of on-state current

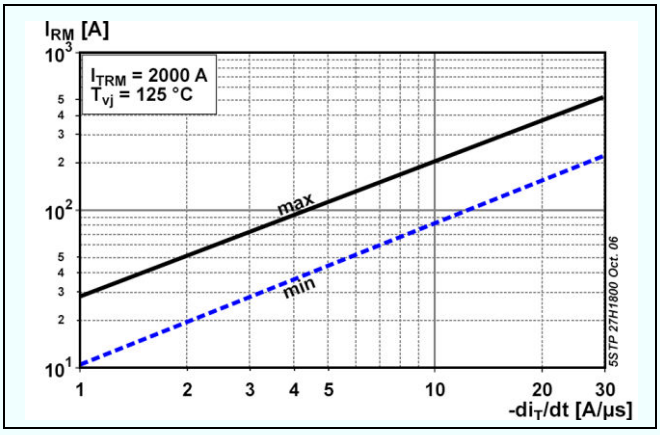


Fig. 11 Peak reverse recovery current vs. decay rate of on-state current

Turn-on and Turn-off losses

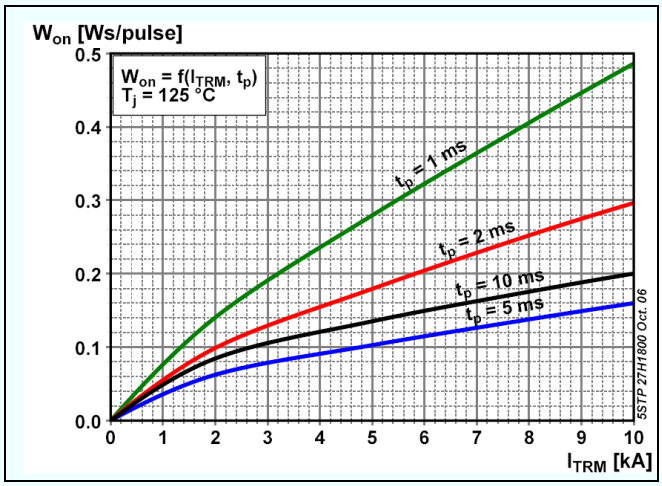


Fig. 12 Turn-on energy, half sinusoidal waves

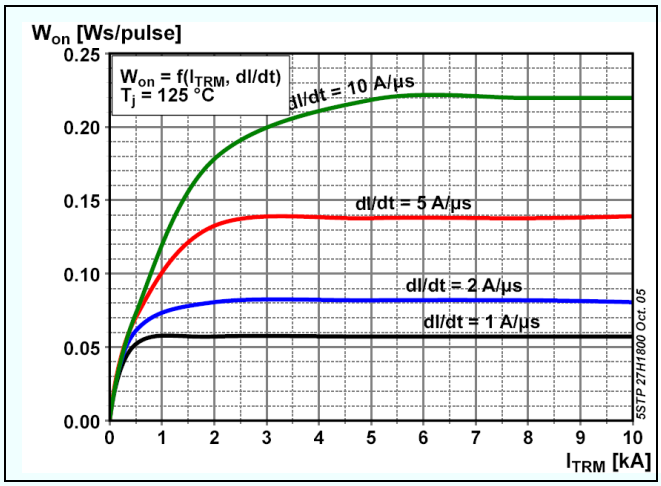


Fig. 13 Turn-on energy, rectangular waves

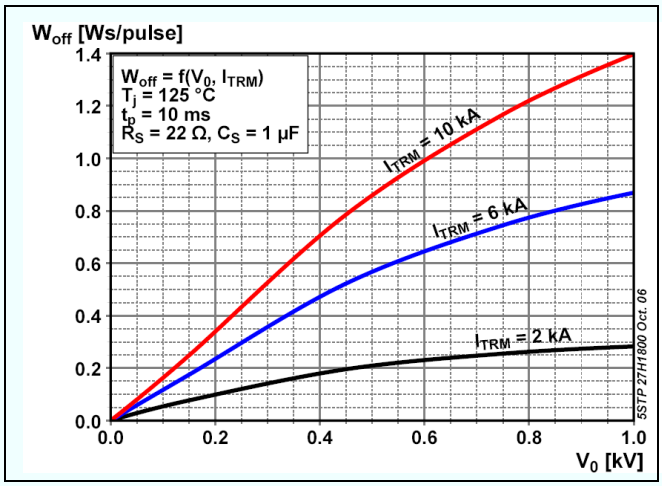


Fig. 14 Turn-off energy, half sinusoidal waves

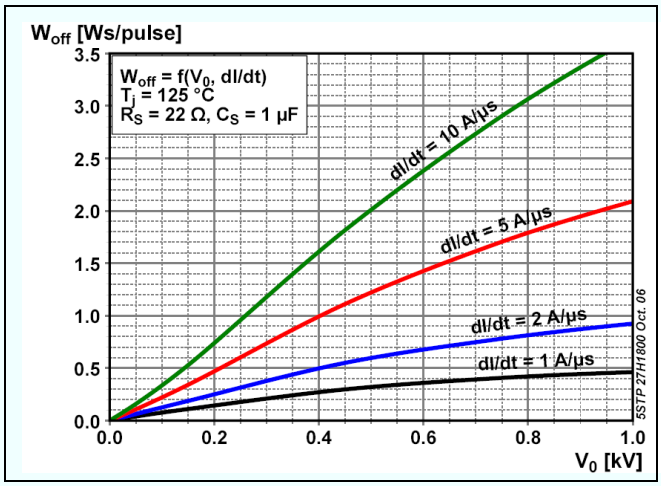


Fig. 15 Turn-off energy, rectangular waves

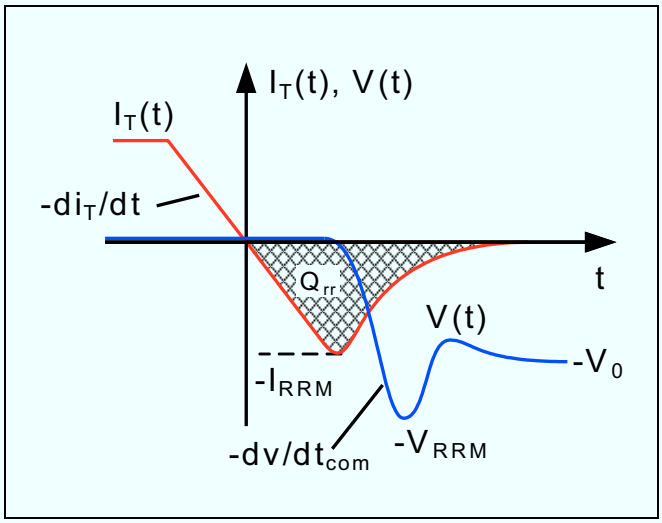


Fig. 16 Current and voltage waveforms at turn-off

Total power loss for repetitive waveforms:

$$P_{TOT} = P_T + W_{on} \cdot f + W_{off} \cdot f$$

where

$$P_T = \frac{1}{T} \int_0^T I_T \cdot V_T(I_T)\ dt$$

Fig. 17 Relationships for power loss

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